

362

362 cored solder wire has been specially formulated to complement no clean wave and reflow soldering processes, providing fast soldering on copper, brass, and solder coated materials.

FEATURES AND BENEFITS

- Rosin based
- Good wetting on most common surface finishes
- Halide activated
- Non-corrosive
- Available in a range of alloys
- Amber residues
- Fast soldering

TYPICAL PROPERTIES

Solder Alloy:

362 cored wires are available in a variety of alloys conforming the purity requirements of J-STD-006 and EN 29453 or alloys conforming to similar national or international standards. A wide range of wire diameters is available manufactured to close dimensional tolerances.

Code	Alloy Composition	Melting Point (°C)
60EN	Sn60Pb40	183-188
Sn63	Sn63Pb37	183
Sn62	Sn62Pb36Ag2	179
SAV6	Sn60Pb38Cu2	183-190
SAV1	Sn50Pb48.5Cu1.5	183-215
40EN	Sn40Pb60	183-235
HMP	Sn5Pb93.5Ag1.5	296-301
99C	Sn99.3Cu0.7	227
96S	Sn96.3Ag3.5	221
96SC	Sn95.5Ag3.8Cu0.7	217

Flux:

362 solid flux is based on a blend of novel activators and resins. It has a mild characteristic odour and leaves dry, non-sticky residues.

Property	Value
Acid Value (mgKOH/g)	170
Halide Content (%)	0.5
Flux Content (%)	3.0

Reliability:

362 flux passes the J-STD-004 SIR test and other elements of J-STD-004 test protocols associated with the flux classification ROL1.

Test	Specification	Test Method	Results
Copper Plate Corrosion	IPC/J-STD-004A	2.6.15C	Pass
Copper Mirror Corrosion	IPC/J-STD-004A	2.3.32D	Pass
Surface Insulation Resistance (SIR) (without cleaning)	IPC/J-STD-004A	2.6.3.7	Pass
Flux Activity Classification (without cleaning)	IPC/J-STD-004A ISO 9454		ROL1 1.1.2

DIRECTIONS FOR USE

Soldering with 362 does not require any special methods or deviation from standard hand soldering practices.

Soldering iron: Good results should be obtained using a range of tip temperatures. However, the optimum tip temperature and heat capacity required for a hand soldering process is a function of both soldering iron design and the nature of the task. Care should be exercised to avoid unnecessarily high tip temperatures for excessive time. A high tip temperature will increase any tendency to flux spitting and it may produce some residue darkening. The soldering iron tip should be properly tinned; this may be achieved using 362 cored solder wire. Severely contaminated soldering iron tips should first be cleaned and pre-tinned using TTC-LF Tip Tinner/Cleaner, then wiped on a clean, damp sponge before re-tinning with 362 cored solder wire.

Soldering process: 362 cored wires contain a careful balance of resins and activators to provide clear residues, maximum activity and high residue reliability without cleaning in most situations. To achieve the best results from 362 solder wires, recommended working practices for hand soldering should be observed as follows:

Apply the soldering iron tip to the work surface, ensuring that it simultaneously contacts the base material and the component termination to heat both surfaces properly. This process should only take a fraction of a second.

Apply 362 flux cored solder wire to a part of the joint surface away from the soldering iron and allow to flow sufficiently to form a sound joint fillet – this should be virtually instantaneous. Do not apply excessive solder or heat to the joint as this may result in dull, gritty fillets and excessive or darkened flux residues.

Remove solder wire from the work piece and then remove the iron tip. The total process will be very rapid, depending upon thermal mass, tip temperature and configuration and the solderability of the surfaces to be joined. 362 flux cored solder wires provide fast soldering on copper and brass surfaces as well as solder coated materials. Activity on nickel is also good depending on the state of oxidation of the nickel finish. The good thermal stability of 362 flux cored solder wire means it is also well suited to soldering applications requiring higher melting lead free alloys.

Do not apply excessive solder to the joint, as this will leave excess flux residues on the surface. Remove solder from work piece and then remove the heat source (iron tip). This total process should take from 0.5 to 1.5 seconds per joint, depending upon mass, iron temperature and tip configuration, along with the solderability of the surfaces. Excessive times or temperatures may exhaust the flux before solder wetting has occurred and may cause increased residue levels.

Note: If the solder is applied directly to the soldering iron tip, the flux may be overheated, and its effectiveness diminished. It may also lead to charring which will contaminate the soldering iron tip.

Cleaning:

362 flux cored solder wires have been formulated to leave pale flux residues and to resist spitting and fuming. Cleaning will not be necessary in most situations but if required this is best achieved using MCF 800 solvent cleaner (see separate technical data sheet). Other proprietary solvent or semi-aqueous processes may be suitable.

Saponification can be suitable, but customers must ensure that the desired level of cleanliness can be achieved by their chosen system.

Storage:

It is recommended to store 362 in a dry environment at room temperature.

Shelf Life:

The cored solder wire is classified as a non-shelf-life item. Thus, no expiry date is required to be printed on the labels. However, the quality and manufacturing records for cored solder wire is only maintained no longer than 2 years from the date of manufacture. Thus, any quality feedback after that stipulated period cannot be addressed.

GENERAL INFORMATION

For safe handling information on this product consult the relevant Safety Data Sheet (SDS)

Disclaimer

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. HARIMA is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product. Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

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